

Datasheet

Nitrogen8M Plus SMARC

Version 2.7

Revision History

Version	Date	Notes	Contributors	Approver
0.1	20 April 2023	Preliminary Release	Gary Bisson	Dan Kephart
1.0	26 July 2023	Update RF Output section Update to R1 version of the schematics Update block diagram	Gary Bisson	Dan Kephart
1.1	19 Jan 2024	Fix PCIe reset signal level Fix I2S2_CK muxing options Add LVDS0 details in comments	Gary Bisson	Jody Van
1.2	22 Feb 2024	Fix I2C_LCD missing definitions	Gary Bisson	Jody Van
2.0	19 April 2024	Converted to Ezurio template	Sue White	Dave Drogowski
2.1	13 June 2024	Added SMARC_CAR to orderable parts.	Dave Drogowski	Jonathan Kaye
2.2	5 September 2024	Added Errata Section Block Diagram Updated (IF573) List of all changes from REV10 to REV20 Updated pin muxing	Jody Van	Gary Bisson
2.3	17 Sep 2024	Removed references to JTAG.	Dave Drogowski	Jody Van
2.4	20 Sep 2024	Added non-wireless parts to Ordering Information	Dave Drogowski	Jonathan Kaye
2.5	8 Jan 2024	Corrected pins P123 to P125 comment to "10k pull-up" in Table 8	Eric Graves	Dave Drogowski
2.6	30 Jan 2025	Added Heatsink Section Updated Mechanical Drawing REV20	Jody Van	Gary Bisson
2.7	13 May 2025	Updated heatsink part number and image	Jody Van	Jonathan Kaye

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1 Scope

This document describes key hardware aspects of Ezurio's Nitrogen8M Plus SMARC system-on-module which is based on the i.MX 8M Plus processor family and the Sona IF573. Data in this document is drawn from several sources and includes information found in the documentation for NXP's i.MX 8M Plus and our Sona IF573.



Note: Information in this document is subject to change. Contact us for the most updated version of this document.

2 Introduction

The Nitrogen8M Plus SMARC is an integrated platform solution with Quad Cortex®-A53 processors operating up to 1.8 GHz and pre-certified tri-band 802.11 a/b/g/n/ac/ax WLAN 2x2 plus dual-mode Bluetooth® 5.4 LE module.

Quad Arm® Cortex®-A53 processors are integrated with an NPU of 2.3 TOPS that greatly accelerates machine learning inference. The vision engine is composed of two MIPI-CSI camera inputs and an HDR-capable Image Signal Processor (ISP) capable of 375 MPixels/s. The advanced multimedia capabilities include several display interfaces, HDMI 2.0a (eARC), MIPI-DSI, and LVDS. These interfaces can utilize the onboard 1080p60 video encode and decode in H.265 and H.264 format, along with an onboard GPU that is a 3D and 2D graphic accelerator supporting 1 GPixel/s, OpenVG 1.1, Open GL ES3.1, Vulkan, and Open CL 1.2 FP. Multiple audio and microphone interfaces are available along with the audio processing capabilities of the HiFi 4 DSP operating at 800MHz for Immersive Audio and Voice systems.

The Nitrogen8M Plus SMARC features an Arm® Cortex®-M7 microcontroller running at 800 MHz for customer applications to offload the Cortex®-A53 processor for real time and low power operation. A variety of robust control networks for industrial applications are possible via CAN-FD interfaces, SPI, I2C, UART, USB 3.0, and dual Gb Ethernet.

The Nitrogen8M Plus SMARC includes the Sona IF573 which is pre-calibrated and integrates the complete transmit/receive RF paths including diplexer, switches, reference crystal oscillator and power management units (PMU). One RF connector (MHF4) on the module provides the most flexibility of antenna selection and installation for the best antenna performance. Several high-performance antennas are certified with the Sona IF573 onboard the Nitrogen8M Plus SMARC. A detailed list of pre-certified antennas list is shown in the module datasheet on the [Nitrogen8M Plus SMARC product page](#). Additionally, the supporting [SMARC_CAR carrier board kit](#), also includes all required antennas for this radio.

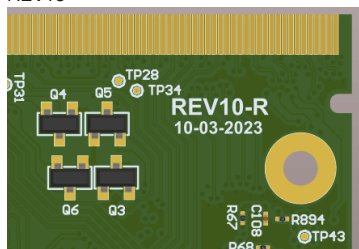
The Nitrogen8M Plus SMARC has several product SKUs providing different eMMC and LPDDR4 memory configurations, see [Ordering Information](#).

3 Change List

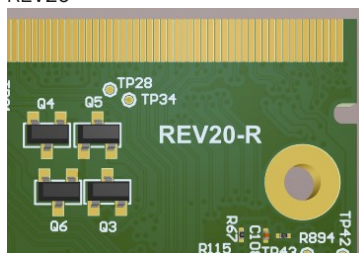
3.1 REV10 to REV20

1. Silkscreen:

a. REV10



b. REV20



2. Switch the Wi-Fi module from the Sterling LWB5+ to the Sona M.2 1216 form factor to ensure compatibility with the entire Sona module family
3. Removal of ESPL_IO2 (S56) and ESPL_RESET# (S58) signals, which are now utilized to control GBEx_LINK100#
4. Addition of GBEx_LINK100# signals (P21 & S19)

4 Errata

4.1 ERRATA1: Missing ground on pin S47

Issue: Due to a model issue, the pin S47 isn't exported in the schematics and therefore is not grounded, hence not complying with the SMARC requirement.

Impact: No HW impact as the 48 other ground pins are properly connected.

Resolution: Connect pin S47 to ground to have 49 grounded pins as per the SMARC standard.

Action: Future revision of the product shall ground pin S47.

5 Nitrogen8M Plus SMARC Features Summary

The Nitrogen8M Plus SMARC module is based on i.MX 8M Plus from NXP which offers a variety of interfaces and different memory configurations. Most of these interfaces are multiplexed and not able to be used simultaneously.

It complies with the [SMARC v2.1 specification from SGET](#).

Key features of Nitrogen8M Plus SMARC are described in [Table 1](#).

Table 1: Key Features of Nitrogen8M Plus SMARC

Feature	Description
CPU	Quad Cortex®-A53 processors operation up to 1.8 GHz 32 KB L1 Instruction Cache 32 KB L1 Data Cache 512 KB unified L2 cache
	Cortex®-M7 core platform operating up to 800 MHz 32 KB L1 Instruction Cache 32 KB L1 Data Cache 256 KB tightly coupled memory (TCM) - ARM Neon™ extension
Image Sensor Processor (ISP)	375 Mpixel/s HDR ISP supporting configurations, such as 12MP@30fps, 4kp45, or 2x 1080p80
Memory interface	- On module: 32-bits LPDDR4 with inline ECC (size, please refer to Ordering Information) - On module: 8-bits eMMC 5.1 with HS400 speed (size, please refer Ordering Information) - SPI - FlexSPI Flash with support for XIP (for Cortex®-M7 in low-power mode) and support for either one Octal SPI, or parallel read mode of two identical Quad SPI FLASH devices.
Graphic Processing Unit	GC7000UL with OpenCL and Vulkan support - Two shaders 166 million triangles/sec 1.0 giga pixel/sec 16 GFLOPs 32-bit - Supports OpenGL ES 1.1, 2.0, 3.0, OpenCL 1.2, Vulkan - Core clock frequency of 1000 MHz - Shader clock frequency of 1000 MHz GC520L for 2D acceleration - Render target compatibility between 3D and 2D GPU (super tile status buffer)
Video Processing Unit	Video Decode 1080p60 HEVC/H.265 Main, Main 10 (up to level 5.1) 1080p60 VP9 Profile 0, 2 1080p60 VP8 1080p60 AVC/H.264 Baseline, Main, High decoder Video Encode 1080p60 AVC/H.264 encoder 1080p60 HEVC/H.265 encoder
Neural Processing Unit (NPU)	2.3 TOP/s Neural Network performance - Keywords detect, noise reduction, beamforming - Speech recognition (i.e., Deep Speech 2) - Image recognition (i.e., ResNet-50)
HDMI 2.0a Tx	HDMI 2.0a Tx supporting one display - Resolutions of 720x480p60, 1280x720p60, 1920x1080p60, 3840x2160p30 - Pixel clock up to 297 MHz

Feature	Description
LCDIF Display Controller	Supports up to 1920x1200p60 display per LCDIF if no more than 2 instances used simultaneously, or 2x 1080p60 + 1x 4kp30 on HDMI if all 3 instances used simultaneously. - One LCDIF drives MIPI DSI, up to UWHD and WUXGA - One LCDIF drives LVDS Tx, up to 1920 x 1080p60 - One LCDIF drives HDMI Tx, up to 4kp30
Camera Interface	Two MIPI-CSI Interfaces 2x 4-lane MIPI-CSI interface (D-PHY v1.2, up to 1.5Gbps) HDR ISP 2x ISP supporting 375 Mpixel/s aggregate performance and up to 3-exposure HDR processing - When one camera is used, supports up to 12MP@30fps or 4kp45 - When two cameras are used, each supports up to 1080p80 - Maximum resolution limited to resolutions achievable with a 250 MHz pixel clock and active pixel rate of 200 Mpixel/s with 24-bit RGB. This includes resolutions such as: 1080p60 - WUXGA (1920X1200) at 60 Hz 1920x1440 at 60 Hz - WHD (2560X1080) at 60 Hz - MIPI DSI: WQHD (2560x1440) can be supported by reduced blanking mode
Audio	- Cadence® Tensilica® HiFi 4 DSP, operating up to 800 MHz - Two I2S (Optionally One as HAD) - All ports support 49.152 MHz BCLK. - ASRC supports processing 32 audio channels, 4 context groups, 8 kHz to 384 kHz sample rate, and 1/16 to 8x sample rate conversion ratio. - eARC/ARC (HDMI)
Connectivity	- One PCI Express (PCIe) Gen3 Single Lane supporting Dual Mode Operation with PHY - Two USB 3.0 Host interfaces (also supports USB 2.0) - Two USB 2.0 Host interfaces (without integrated PHY) + One USB 2.0 OTG interface - One Ultra Secure Digital Host Controller (uSDHC) interface - Two Gigabit Ethernet controllers (both capable of simultaneous operation) - Two Controller Area Network (FlexCAN) modules, each optionally supporting flexible data-rate (FD, available on Industrial parts only) Note: Flexible Data (FD) mode supports MB operation only with no RX FIFO or DMA support. - Three Universal Asynchronous Receiver/Transmitter (UART) modules - Five I2C modules - Three SPI modules
Security	- Resource Domain Controller (RDC) - Arm® TrustZone® (TZ) architecture - On-chip RAM (OCRAM) secure region protection using OCRAM controller - High Assurance Boot (HAB) - Cryptographic Acceleration and Assurance Module (CAAM) - Secure Non-Volatile Storage (SNVS)
Debug Interface	Two Debug UART ports for Quad Cortex®-A53 processors and Cortex®-M7.
RF output	RF output with MHF4 connectors provides flexible external antenna selection for optimized performance for both Wi-Fi and BT

6 Block Diagram

The figure below shows the block diagram of the Nitrogen8M Plus SMARC which contains the NXP i.MX 8M Plus processor, PMIC (PCA9450CHN) and the Sona IF573.

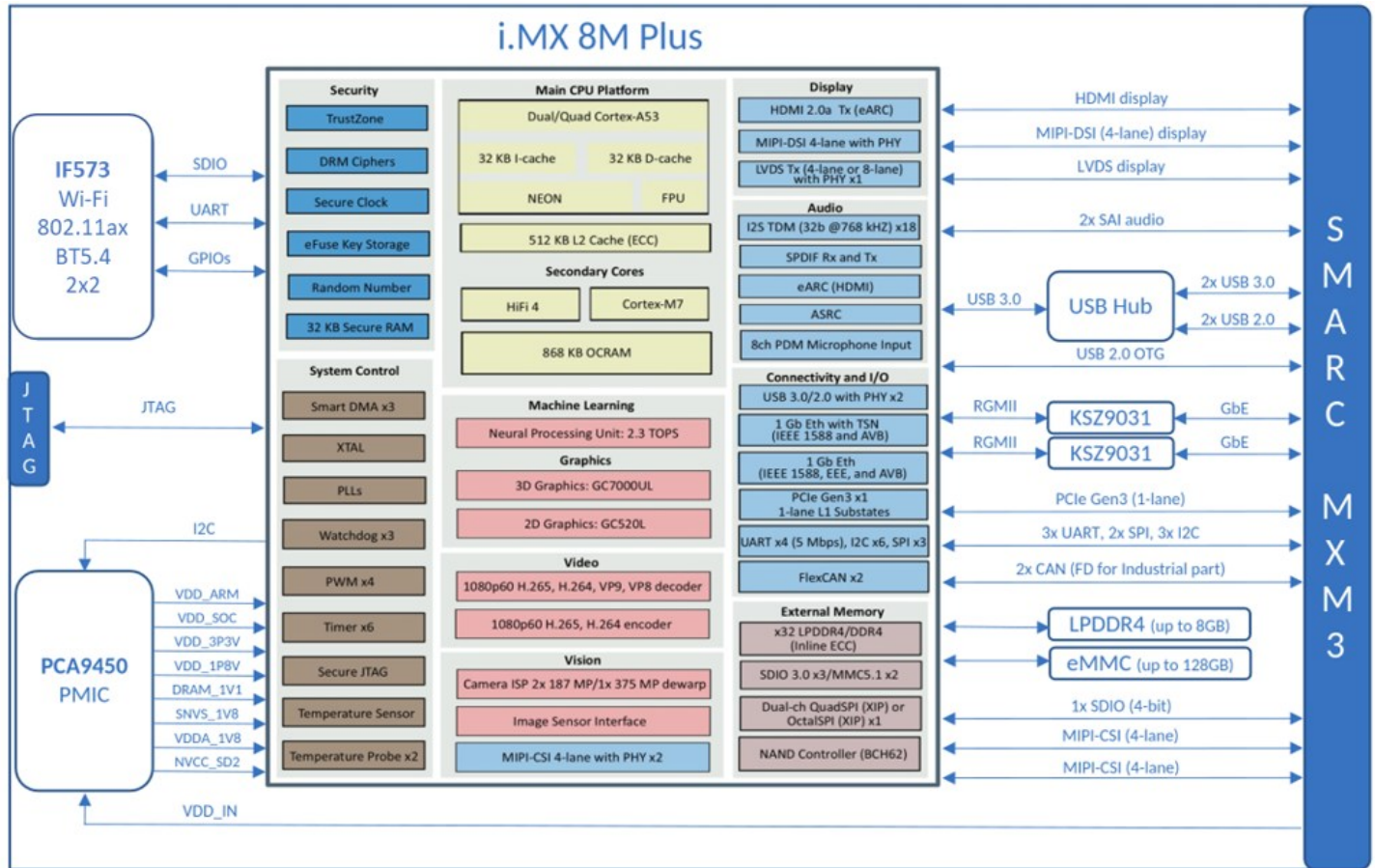


Figure 1: Nitrogen8MP SMARC block diagram

Detailed connections between the SONA IF573 and the i.MX 8M Plus are detailed in Table 2 below.

Table 2: Sona IF573 to i.MX 8M Plus Connections

	IF573	i.MX8M Plus
SDIO	SD_CLK/SD_CMD/SD_DATA0-3	SD3_CLK/SD3_CMD/SD3_DATA0-3
UART	UART_RX/UART_TX/UART_CTS/UART RTS	UART1_TXD/UART1_TXD/UART3_RXD/UART3_TXD
CLK	SUSCLK	CLKOUT1
BT_EN	W_DISABLE2#	NAND_CE2
BT_IRQ	BT_HOST_WAKE	SAI5_RXD0
WL_EN	W_DISABLE1#	NAND_CE3
WL_IRQ	SDIO_WAKE#	NAND_DQS

7 DC Power Tree

The Nitrogen8M Plus SMARC requires a primary 5V power supply (VSYS) input. This supply is the main power domain to the on-module NXP PCA9450CHN power management IC (PMIC), which generates all required supply voltages for the module components. The PMIC has 32.768KHz crystal oscillator and buffer built-in which generates the real-time clock (RTC) for the NXP processor and Wi-Fi radio.

7.1 Power Modes Diagram

NXP PCA9450CHN has eight power modes: OFF, READY, SNVS, RUN, STANDBY, PWRDN, PWRUP and FAULT_SD. Below figure shows the state transition diagram showing the conditions to enter and exit each state.

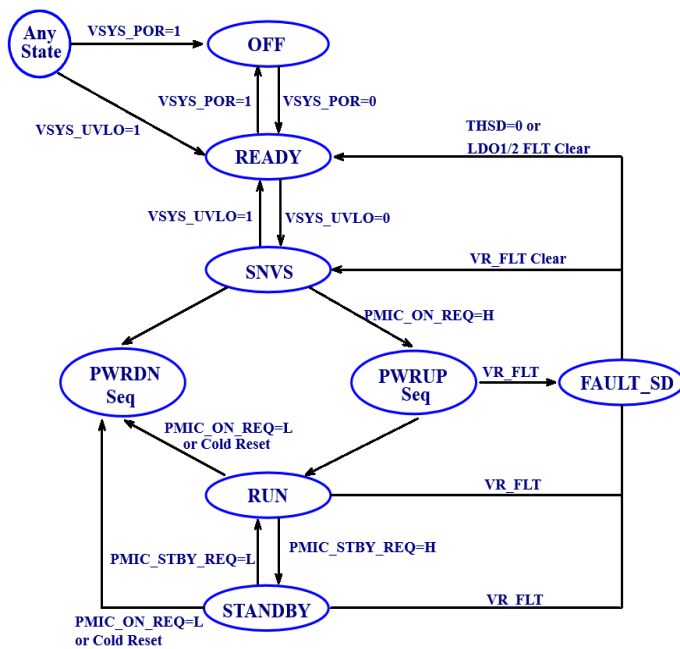


Figure 2: State transition diagram for PMIC

- OFF mode:**
 PMIC will enter OFF mode from any state when the main power source VSYS_5V falls below $V_{\text{sys_POR}}$ threshold (2.2 to 2.6V; typ.=2.4V). All regulators are OFF and all registers are reset in this mode.
- READY Mode:**
 PMIC enters READY mode when VSYS_5V is higher than $V_{\text{sys_POR}}$. The internal LDO VINT is enabled and loads the MTP data to registers. Once the MTP data loading is complete, the state machine is ready to transition to SNVS mode.
- SNVS Mode:**
 PMIC will enter SNVS (Secure Non-Volatile Storage mode) when VSYS_5V exceeds the $V_{\text{sys_UVLO}}$ threshold. LDO1 is powered up and the 32.778KHz buffer starts running. RTC_RESET_B is pulled high after both LDO1 and LDO2 voltage come up.

Note: PMIC_ON_REQ input is masked until RTC_RESET_B is released. PMIC will start power up sequence if PMIC_ON_REQ is asserted high in this mode.

- PWRUP Mode:**
 After RTC_RESET_B is released in SNVS mode, the PMIC starts power up with a pre-defined sequence with PMIC_ON_REQ asserted high. During PWRUP mode, PMIC_STBY_REQ signal is masked until POR_B is released. The PWRUP mode ends up releasing POR_B and the PMIC is transitioned to RUN mode.
- PWRDN Mode:**
 When PMIC_ON_REQ is low in RUN or STANDBY mode, PMIC enters PWRDN mode, where it starts with pulling down POR_B. and then by turning off each power rail before transitioning to SNVS mode.
- RUN Mode:**
 PMIC operates in RUN mode when PMIC_ON_REQ is driven high and PMIC_STBY_REQ is driven low. When PMIC_STBY_REQ is asserted high in this mode, it is transitioned to STANDBY mode. PMIC_ON_REQ is asserted low, it moves to PWRDN mode.

- STANDBY Mode:**

PMIC is transitioned to STANDBY mode from RUN mode when both PMIC_ON_REQ and PMIC_STBY_REQ are driven low. If PMIC_ON_REQ is asserted low, then it is transitioned to PWRDN mode. If PMIC_STBY_REQ is driven low, it is transitioned to RUN mode.

Table 3: Power modes

Power Mode	VSYS_5V	PMIC_ON_REQ	PMIC_STBY_REQ
OFF	$VSYS_5V < V_{SYS_POR}$	x	x
READY	$VSYS_5V > V_{SYS_POR}$	x	x
SNVS	$VSYS_5V > V_{SYS_UVLO}$	LOW	x
STANDBY	$VSYS_5V > V_{SYS_UVLO}$	HIGH	HIGH
RUN	$VSYS_5V > V_{SYS_UVLO}$	HIGH	LOW

- FAULT_SD Mode:**

PCA9450CHN has three kinds of Fault sources.

- **Thermal shutdown:** Transition to SNVS mode or READY mode after Fault_SD mode.
When junction temperature reaches 150°C, it enters FAULT_SD mode after 120 μ s where regulators are tuned off simultaneously. It stays at FAULT_SD mode until the junction temperature fall below 150°C, then move to READY state if any of LDO1 and LDO2 is fault is triggered. And it will move to SNVS mode if either LDO1 or LDO2 fault is triggered.
- **Voltage regulator fault during power up:** Transition to READY mode after FAULT_SD mode.
Any POK of voltage regulator doesn't come up within 10ms after regulator is enabled during power up sequence, it stops power-up sequence and then moves into FAULT_SD mode where all regulators are turned off.
- **Voltage regulator fault in STBY and RUN MODE:** Move to FAULT_SD mode in 100ms after fault is detected. Transition to SNVS mode or READY mode after FAULT_SD mode.

8 Boot Mode

The Nitrogen8M Plus SMARC module contains a switch (**SW1**) connected to BOOT_MODE0 thus allowing to switch from internal fuses boot (eMMC by default) to USB serial downloader.

The other boot mode signals (BOOT_MODE[1-3]) are exposed to the carrier to SMARC BOOT_SEL[0-2] signals.

This allows more combinations as shown in Table 4.

Table 4: Boot mode combinations

BOOT_MODE3	BOOT_MODE2	BOOT_MODE1	BOOT_MODE0	BOOT MODE
0	0	0	0	Boot from Internal Fuses
0	0	0	1	USB Serial Download
0	0	1	0	uSDHC3 (eMMC boot only, SD3 8-bit) Default.
0	0	1	1	uSDHC2 (SD boot, SD2)
0	1	0	0	NAND 8-bit single device 256 pages.
0	1	0	1	NAND 8-bit single device 512 pages
0	1	1	0	QSPI 3B Read
0	1	1	1	QSPI Hyperflash 3.3V
1	0	0	0	ECSPI Boot
1	0	0	1	Reserved
1	0	1	0	Reserved
1	0	1	1	Reserved
1	1	0	0	Reserved (Boot on I2C connected to BOOT PIN[3:2])
1	1	0	1	Reserved
1	1	1	0	Infinite Loop Mode
1	1	1	1	Test Mode

Caution: BOOT_MODE0, BOOT_MODE1, BOOT_MODE2, BOOT_MODE3, and POR_B must be pulled to "11111" for i.MX8M Plus to enter Boundary Scan Mode.

9 Electrical Characteristic and Power Consumption

9.1 Absolute Maximum Ratings

Table 5 summarizes the absolute maximum ratings and Table 6 lists the recommended operating conditions for the Nitrogen8M Plus SMARC product series. Absolute maximum ratings are those values beyond which damage to the device can occur. Functional operation under these conditions, or at any other condition beyond those indicated in the operational sections of this document, is not recommended.

Note: Maximum rating for signals follows the supply domain of the signals.

Table 5: Absolute maximum ratings

Symbol (Domain)	Parameter	Min.	Max	Unit
VSYS_5V	Input voltage for the SOM	-0.5	+6.0	V
I/O Input/output voltage range	Any I/O pin referred to VDD_1V8; VDDA_1V8; WI-FI_1V8; NVCC_SNVs_1V8	-0.3	+2.1	V
I/O Input/output voltage range	Any I/O pin referred to VDD_3V3; VSD_3V3; NVCC_SD2	-0.3	+3.6	V
T _{STORAGE}	Storage Temperature Range	-40	+125	°C
ANT0; ANT1	Maximum RF input (reference to 50-Ω input)	NA	+10	dBm
ESD	Electrostatic discharge tolerance	-2000	+200 0	V

9.2 Recommended Operating Conditions

Table 6: Recommended operating conditions

Symbol (Domain)	Parameter	Min.	Typ.	Max.	Unit
VSYS_5V	Input voltage for the SOM	3.3	5.0	5.5	V
I/O Input/output voltage range	Any I/O pin referred to VDD_1V8; VDDA_1V8; WI-FI_1V8; NVCC_SNVs_1V8	1.71	1.8	1.89	V
I/O Input/output voltage range	Any I/O pin referred to VDD_3V3; VSD_3V3; NVCC_SD2	3.0	3.3	3.6	V
T-ambient	Operating Ambient temperature	-40	25	85	°C

Note: The operating ambient temperature ratings are highly dependent on the design-case, such as the enclosure design, system design, processor activity, GPU/VPU activity, and peripherals used.

Running over 70° C ambient temperature typically requires the implementation of thermal management strategies such as passive (heatsink/spreader). Please [contact Ezurio](#) if you need information and guidance for thermal management.

9.3 DC Current Consumption

Several power saving modes are available and are listed in Table 7.

Table 7: Typical current consumption

Mode	Description	Current (Avg)
Power Saving mode	CPU is on, Stay on Wi-Fi connection only.	431mA
RAM suspend mode	CPU is on, memory and wireless connection are off.	7.7mA
Linux graceful power down mode	All circuits are off. Only the NVCC_SNVs_1V8 PMU is alive and ONOFF pin is accessible to allow turn on of the SOM.	154uA

10 Module Pin Out and Pinmux Table

Table 8 lists the pin multiplexing (PIN-MUX) of the Nitrogen8M Plus SMARC. Most of the pin names on the SOM are same as the pin names of the connected NXP processor. The "Pin Number" column shows the relationship of the SOM pin number to the NXP processor pin number.

PO = Power Output, PI = Power Input, DI = Digital Input, DO = Digital Output, DIO = Bi-directional Digital Port, GND = Ground

NXP process has configurable internal Pull-up (PU) and pull-down (PD) resistor whose values are listed below. During a reset condition, the PU and PD state are pre-defined and cannot be changed.

Table 8: Resistor characteristics

Parameter	Conditions	Min	Typ	Max	Unit
Pull-up (PU) resistor	VDD=1.65 to 1.95V	12	22	49	k Ω
Pull-down (PD) resistor	Temp=0 to 95°C	13	23	48	k Ω
Pull-up (PU) resistor	VDD=3.0 to 3.6V	18	37	72	k Ω
Pull-down (PD) resistor	Temp=0 to 95°C	24	43	87	k Ω

Pin configuration for the i.MX is achieved using a suite of evaluation and configuration tools that assists users from initial evaluation to production software development. Users can download the tool from the NXP website: https://www.nxp.com/design/designs/config-tools-for-i-mx-applications-processors:CONFIG-TOOLS-IMX?tab=Design_Tools_Tab

Table 8: Pinout table for Nitrogen8M Plus SMARC edge connector (J2)

SMARC Pin #	SMARC Pin Name	CPU PIN / Multiplexing (red = default muxing)	I/O	I/O Level	Comments
P1	SMB_ALERT#	SAI: SAI1_RXD0 PDM: PDM_BIT_STREAM00 ENET1: 1588_EVENT1_IN GPIO: GPIO4_IO02	DI	1.8 to 5 V	
P2	GND	NA	-	NA	
P3	CSI1_CK+	MIPI_CSI2_CLK_P	DO	1.8V	
P4	CSI1_CK-	MIPI_CSI2_CLK_N	DO	1.8V	
P5	GBE1_SDP	GPIO: GPIO4_IO01 SAI: SAI1_RXC PDM: PDM_CLK ENET1: 1588_EVENT0_OUT	DI/O	3.3V	
P6	GBE0_SDP	GPIO: GPIO1_IO09 ENET: 1588_EVENT0_OUT PWM: PWM2_OUT ISP: ISP_SHUTTER_OPEN_1 USDHC: USDHC3_RESET_B DMA: SDMA2_EXT_EVENT00	DI/O	3.3V	
P7	CSI1_RX0+	MIPI_CSI2_D0_P	DI	1.8V	
P8	CSI1_RX0-	MIPI_CSI2_D0_N	DI	1.8V	
P9	GND	NA	-	NA	
P10	CSI1_RX1+	MIPI_CSI2_D1_P	DI	1.8V	
P11	CSI1_RX1-	MIPI_CSI2_D1_N	DI	1.8V	
P12	GND	NA	-	NA	
P13	CSI1_RX2+	MIPI_CSI2_D2_P	DI	1.8V	
P14	CSI1_RX2-	MIPI_CSI2_D2_N	DI	1.8V	
P15	GND	NA	-	NA	

SMARC Pin #	SMARC Pin Name	CPU PIN / Multiplexing (red = default muxing)	I/O	I/O Level	Comments
P16	CSI1_RX3+	MIPI_CSI2_D3_P	DI	1.8V	
P17	CSI1_RX3-	MIPI_CSI2_D3_N	DI	1.8V	
P18	GND	NA	-	NA	
P19	GBE0_MDI3-	TXRXM_D	DI/O	1.8V	From KSZ9031 (U8)
P20	GBE0_MDI3+	TXRXP_D	DI/O	1.8V	From KSZ9031 (U8)
P21	GBE0_LINK100#	LED2	DO	3.3V	From KSZ9031 (U8) LED2 if GPA5 is low
P22	GBE0_LINK1000#	LED2	DO	3.3V	From KSZ9031 (U8) LED2 if GPA5 is high
P23	GBE0_MDI2-	TXRXM_C	DI/O	1.8V	From KSZ9031 (U8)
P24	GBE0_MDI2+	TXRXP_C	DI/O	1.8V	From KSZ9031 (U8)
P25	GBE0_LINK_ACT#	LED1	DO	3.3V	From KSZ9031 (U8)
P26	GBE0_MDI1-	TXRXM_B	DI/O	1.8V	From KSZ9031 (U8)
P27	GBE0_MDI1+	TXRXP_B	DI/O	1.8V	From KSZ9031 (U8)
P28	GBE0_CTREF	TP28	-	NA	Test point
P29	GBE0_MDI0-	TXRXM_A	DI/O	1.8V	From KSZ9031 (U8)
P30	GBE0_MDI0+	TXRXP_A	DI/O	1.8V	From KSZ9031 (U8)
P31	SPI0_CS1#	GPIO: GPIO1_IO01 PWM: PWM1_OUT ISP: ISP_SHUTTER_TRIG_0 CLK: CCM_EXT_CLK2	DO	1.8V	
P32	GND	NA	-	NA	
P33	SDIO_WP	USDHC: USDHC2_WP GPIO: GPIO2_IO20 DEBUG: CORESIGHT_EVENT1	DI	1.8 or 3.3V	
P34	SDIO_CMD	USDHC: USDHC2_CMD SPI: ECSPi2_MOSI UART: UART4_DCE_TX UART: UART4_DTE_RX PDM: AUDIOMIX_PDM_CLK GPIO: GPIO2_IO14	DI/O	1.8 or 3.3V	
P35	SDIO_CD#	USDHC: USDHC2_CD_B GPIO: GPIO2_IO12	DI	1.8 or 3.3V	
P36	SDIO_CK	USDHC: USDHC2_CLK SPI: ECSPi2_SCLK UART: UART4_DCE_RX UART: UART4_DTE_TX PDM: AUDIOMIX_PDM_CLK GPIO: GPIO2_IO13	DO	1.8 or 3.3V	
P37	SDIO_PWR_EN	USDHC: USDHC2_CD_B GPIO: GPIO2_IO12 DEBUG: SRC_SYSTEM_RESET	DO	3.3V	
P38	GND	NA	-	NA	

SMARC Pin #	SMARC Pin Name	CPU PIN / Multiplexing (red = default muxing)	I/O	I/O Level	Comments
P39	SDIO_D0	USDHC: USDHC2_DATA0 I2C: I2C4_SDA UART: UART2_DCE_RX UART: UART2_DTE_TX PDM: AUDIOMIX_PDM_BIT_STREAM00 GPIO: GPIO2_IO15	DI/O	1.8 or 3.3V	
P40	SDIO_D1	USDHC: USDHC2_DATA1 I2C: I2C4_SCL UART: UART2_DCE_TX UART: UART2_DTE_RX PDM: AUDIOMIX_PDM_BIT_STREAM01 GPIO: GPIO2_IO16	DI/O	1.8 or 3.3V	
P41	SDIO_D2	USDHC: USDHC2_DATA2 SPI: ECSPI2_SS0 SPDIF: AUDIOMIX_SPDIF1_OUT PDM: AUDIOMIX_PDM_BIT_STREAM04 GPIO: GPIO2_IO17	DI/O	1.8 or 3.3V	
P42	SDIO_D3	USDHC: USDHC2_DATA3 SPI: ECSPI2_MISO SPDIF: AUDIOMIX_SPDIF1_IN PDM: AUDIOMIX_PDM_BIT_STREAM03 GPIO: GPIO2_IO18 DEBUG: SRC_EARLY_RESET	DI/O	1.8 or 3.3V	
P43	SPI0_CS0#	SPI: ECSPi1_SS0 UART: UART3_DCE_RTS UART: UART3_DTE_CTS I2C: I2C2_SDA SAI: AUDIOMIX_SAI7_TX_SYNC GPIO: GPIO5_IO09	DO	1.8V	
P44	SPI0_CK	SPI: ECSPi1_SCLK UART: UART3_DCE_RX UART: UART3_DTE_TX I2C: I2C1_SCL SAI: AUDIOMIX_SAI7_RX_SYNC GPIO: GPIO5_IO06	DO	1.8V	
P45	SPI0_DIN	SPI: ECSPi1_MISO UART: UART3_DCE_CTS UART: UART3_DTE_RTS I2C: I2C2_SCL SAI: AUDIOMIX_SAI7_RX_DATA00 GPIO: GPIO5_IO08	DI	1.8V	
P46	SPI0_DO	SPI: ECSPi1_MOSI UART: UART3_DCE_TX UART: UART3_DTE_RX I2C: I2C1_SDA SAI: AUDIOMIX_SAI7_RX_BCLK GPIO: GPIO5_IO07	DO	1.8V	

SMARC Pin #	SMARC Pin Name	CPU PIN / Multiplexing (red = default muxing)	I/O	I/O Level	Comments
P47	GND	NA	-	NA	
P48	SATA_TX+	MIPI_CSI1_D2_P	DI	1.8V	SMARC exception
P49	SATA_TX-	MIPI_CSI1_D2_N	DI	1.8V	SMARC exception
P50	GND	NA	-	NA	
P51	SATA_RX+	MIPI_CSI1_D3_P	DI	1.8V	SMARC exception
P52	SATA_RX-	MIPI_CSI1_D3_N	DI	1.8V	SMARC exception
P53	GND	NA	-	NA	
P54	SPI1_CS0# / ESPI_CS0# / QSPI_CS0#	SPI: ECSPi2_SS0 UART: UART4_DCE_RTS UART: UART4_DTE_CTS I2C: I2C4_SDA CLK: CCM_CLK02 GPIO: GPIO5_IO13	DO	1.8V	
P55	SPI1_CS1# / ESPI_CS1# / QSPI_CS1#	SAI: AUDIOMIX_SAI1_MCLK SAI: AUDIOMIX_SAI1_TX_BCLK ENET: ENET1_TX_CLK GPIO: GPIO5_IO09	DO	1.8V	
P56	SPI1_CK / ESPI_CK / QSPI_CK	SPI: ECSPi2_SCLK UART: UART4_DCE_RX UART: UART4_DTE_TX I2C: I2C3_SCL SAI: AUDIOMIX_SAI7_TX_BCLK GPIO: GPIO5_IO10	DO	1.8V	
P57	SPI1_DIN / ESPI_IO_1 / QSPI_IO_1	SPI: ECSPi2_MISO UART: UART4_DCE_CTS UART: UART4_DTE_RTS I2C: I2C4_SCL SAI: AUDIOMIX_SAI7_MCLK CLK: CCM_CLK01 GPIO: GPIO5_IO12	DI	1.8V	
P58	SPI1_DO / ESPI_IO_0 / QSPI_IO_0	SPI: ECSPi2_MOSI UART: UART4_DCE_TX UART: UART4_DTE_RX I2C: I2C3_SDA SAI: AUDIOMIX_SAI7_TX_DATA00 GPIO: GPIO5_IO11	DO	1.8V	
P59	GND	NA	-	NA	
P60	USB0+	USB1_D_P	DI/O	3.3V	
P61	USB0-	USB1_D_N	DI/O	3.3V	
P62	USB0_EN_OC#	GPIO: GPIO1_IO13 USB: USB1_OTG_OC PWM: PWM2_OUT	DI	3.3V	
P63	USB0_VBUS_DET	USB1_VBUS	DI	5V	
P64	USB0_OTG_ID	USB1_ID	DI	3.3V	

SMARC Pin #	SMARC Pin Name	CPU PIN / Multiplexing (red = default muxing)	I/O	I/O Level	Comments
P65	USB1+	USB2DN_DP2	DI/O	3.3V	From USB Hub (U9)
P66	USB1-	USB2DN_DM2	DI/O	3.3V	From USB Hub (U9)
P67	USB1_EN_OC#	PRT_CTL2	DI	3.3V	From USB Hub (U9)
P68	GND	NA	-	NA	
P69	USB2+	USB2DN_DP3	DI/O	3.3V	From USB Hub (U9)
P70	USB2-	USB2DN_DM3	DI/O	3.3V	From USB Hub (U9)
P71	USB2_EN_OC#	PRT_CTL3	DI	3.3V	From USB Hub (U9)
P72	RSVD	CLKOUT2	DO	1.8V	
P73	RSVD	NA	-	NA	
P74	USB3_EN_OC#	PRT_CTL1	DI	3.3V	From USB Hub (U9)
P75	PCIE_A_RST#	SAI: AUDIOMIX_SAI2_RX_SYNC SAI: AUDIOMIX_SAI5_TX_SYNC SAI: AUDIOMIX_SAI5_TX_DATA01 SAI: AUDIOMIX_SAI2_RX_DATA01 UART: UART1_DCE_TX UART: UART1_DTE_RX GPIO: GPIO4_IO21 PDM: AUDIOMIX_PDM_BIT_STREAM02	DO	3.3V	
P76	USB4_EN_OC#	PRT_CTL4	DI	3.3V	From USB Hub (U9)
P77	PCIE_B_CKREQ#	NA	-	NA	
P78	PCIE_A_CKREQ#	SAI: AUDIOMIX_SAI1_RX_SYNC ENET: ENET1_1588_EVENT0_IN GPIO: GPIO4_IO00	DI/O	3.3V	
P79	GND	NA	-	NA	
P80	PCIE_C_REFCK+	NA	-	NA	
P81	PCIE_C_REFCK-	NA	-	NA	
P82	GND	NA	-	NA	
P83	PCIE_A_REFCK+	PCIE_REF_PAD_CLK_P	DO	1.8V	
P84	PCIE_A_REFCK-	PCIE_REF_PAD_CLK_N	DO	1.8V	
P85	GND	NA	-	NA	
P86	PCIE_A_RX+	PCIE_RXN_P	DO	1.8V	
P87	PCIE_A_RX-	PCIE_RXN_N	DO	1.8V	
P88	GND	NA	-	NA	
P89	PCIE_A_TX+	PCIE_TXN_P	DO	1.8V	
P90	PCIE_A_TX-	PCIE_TXN_N	DO	1.8V	
P91	GND	NA	-	NA	
P92	HDMI_D2+ / DP1_LANE0+	HDMI_TX2_P	DO	1.8V	
P93	HDMI_D2- / DP1_LANE0-	HDMI_TX2_N	DO	1.8V	

SMARC Pin #	SMARC Pin Name	CPU PIN / Multiplexing (red = default muxing)	I/O	I/O Level	Comments
P94	GND	NA	-	NA	
P95	HDMI_D1+ / DP1_LANE1+	HDMI_TX1_P	DO	1.8V	
P96	HDMI_D1- / DP1_LANE1-	HDMI_TX1_N	DO	1.8V	
P97	GND	NA	-	NA	
P98	HDMI_D0+ / DP1_LANE2+	HDMI_TX0_P	DO	1.8V	
P99	HDMI_D0- / DP1_LANE2-	HDMI_TX0_N	DO	1.8V	
P100	GND	NA	-	NA	
P101	HDMI_CK+ / DP1_LANE3+	HDMI_TXC_P	DO	1.8V	
P102	HDMI_CK- / DP1_LANE3-	HDMI_TXC_N	DO	1.8V	
P103	GND	NA	-	NA	
P104	HDMI_HPD / DP1_HPD	HDMI_HPD	DI	1.8V	
P105	HDMI_CTRL_CK / DP1_AUX+	HDMI_DDC_SCL	DI/O	1.8V	
P106	HDMI_CTRL_DAT / DP1_AUX-	HDMI_DDC_SDA	DI/O	1.8V	
P107	DP1_AUX_SEL	HDMI_CEC	DI/O	1.8V	SMARC exception
P108	GPIO0 / CAM0_PWR#	GPA0	DI/O	1.8V	From GPIO expander (U14)
P109	GPIO1 / CAM1_PWR#	GPA1	DI/O	1.8V	From GPIO expander (U14)
P110	GPIO2 / CAM0_RST#	GPA2	DI/O	1.8V	From GPIO expander (U14)
P111	GPIO3 / CAM1_RST#	GPA3	DI/O	1.8V	From GPIO expander (U14)
P112	GPIO4 / HDA_RST#	GPA4	DI/O	1.8V	From GPIO expander (U14)
P113	GPIO5 / PWM_OUT	SPDIF: AUDIOMIX_SPDIF1_OUT PWM: PWM3_OUT I2C: I2C5_SCL TIMER: GPT1_COMPARE1 CAN: CAN1_TX GPIO: GPIO5_IO03	DI/O	1.8V	
P114	GPIO6 / TACHIN	GPA6	DI/O	1.8V	From GPIO expander (U14)
P115	GPIO7	GPA7	DI/O	1.8V	From GPIO expander (U14)
P116	GPIO8	GPB1	DI/O	1.8V	From GPIO expander (U14)
P117	GPIO9	GPB2	DI/O	1.8V	From GPIO expander (U14)
P118	GPIO10	GPB3	DI/O	1.8V	From GPIO expander (U14)
P119	GPIO11	SAI: AUDIOMIX_SAI1_TX_DATA06 SAI: AUDIOMIX_SAI6_RX_SYNC SAI: AUDIOMIX_SAI6_TX_SYNC ENET: ENET1_RX_ER GPIO: GPIO4_IO18	DI/O	1.8V	
P120	GND	NA	-	NA	

SMARC Pin #	SMARC Pin Name	CPU PIN / Multiplexing (red = default muxing)	I/O	I/O Level	Comments
P121	I2C_PM_CLK	I2C: I2C4_CLK PWM: PWM2_OUT PCI: PCIE_CLKREQ_B SPI: ECSPI2_MISO GPIO: GPIO5_IO20	DI/O	1.8V	
P122	I2C_PM_DAT	I2C: I2C4_SDA PWM: PWM1_OUT SPI: ECSPI2_SS0 GPIO: GPIO5_IO21	DI/O	1.8V	
P123	BOOT_SEL0#	BOOT_MODE1	DI	1.8V	10k pull-up
P124	BOOT_SEL1#	BOOT_MODE2	DI	1.8V	10k pull-up
P125	BOOT_SEL2#	BOOT_MODE3	DI	1.8V	10k pull-up
P126	RESET_OUT#	GPB5	DI/O	1.8V	From GPIO expander (U14)
P127	RESET_IN#	POR_B	DI	1.8V	
P128	POWER_BTN#	ONOFF	DI	1.8 - 5V	
P129	SER0_TX	UART: UART4_DCE_TX UART: UART4_DTE_RX UART: UART2_DCE_RTS UART: UART2_DTE_CTS TIMER: GPT1_CAPTURE1 I2C: I2C6_SDA GPIO: GPIO5_IO29	DO	1.8V	
P130	SER0_RX	UART: UART4_DCE_RX UART: UART4_DTE_TX UART: UART2_DCE_CTS UART: UART2_DTE_RTS PCI: PCIE_CLKREQ_B TIMER: GPT1_COMPARE1 I2C: I2C6_SCL GPIO: GPIO5_IO28	DI	1.8V	
P131	SER0_RTS#	NAND: NAND_DATA03 SPI: FLEXSPI_A_DATA03 SDHC: USDHC3_WP UART: UART4_DCE_RTS UART: UART4_DTE_CTS ISP: ISP_FL_TRIG_1 GPIO: GPIO3_IO09 DEBUG: CORESIGHT_TRACE07	DI	1.8V	
P132	SER0_CTS#	NAND: NAND_DATA02 SPI: FLEXSPI_A_DATA02 SDHC: USDHC3_CD_B UART: UART4_DCE_CTS UART: UART4_DTE_RTS I2C: I2C4_SDA GPIO: GPIO3_IO08 DEBUG: CORESIGHT_TRACE06	DO	1.8V	
P133	GND	NA	-	NA	

SMARC Pin #	SMARC Pin Name	CPU PIN / Multiplexing (red = default muxing)	I/O	I/O Level	Comments
P134	SER1_TX	UART: UART2_DCE_TX UART: UART2_DTE_RX SPI: ECPI3_SS0 TIMER: GPT1_COMPARE2 GPIO: GPIO5_IO25	DO	1.8V	
P135	SER1_RX	UART: UART2_DCE_TX UART: UART2_DTE_RX SPI: ECPI3_SS0 TIMER: GPT1_COMPARE2 GPIO: GPIO5_IO24	DI	1.8V	
P136	SER2_TX	SPI: ECPI1_MOSI UART: UART3_DCE_TX UART: UART3_DTE_RX I2C: I2C1_SDA SAI: AUDIOMIX_SAI7_RX_BCLK GPIO: GPIO5_IO07	DO	1.8V	
P137	SER2_RX	SPI: ECPI1_SCLK UART: UART3_DCE_RX UART: UART3_DTE_TX I2C: I2C1_SCL SAI: AUDIOMIX_SAI7_RX_SYNC GPIO: GPIO5_IO06	DI	1.8V	
P138	SER2_RTS#	NA	-	NA	
P139	SER2_CTS#	NA	-	NA	
P140	SER3_TX	NA	-	NA	
P141	SER3_RX	NA	-	NA	
P142	GND	NA	-	NA	
P143	CAN0_TX	SAI: AUDIOMIX_SAI5_RX_DATA01 SAI: AUDIOMIX_SAI1_TX_DATA03 SAI: AUDIOMIX_SAI1_TX_SYNC SAI: AUDIOMIX_SAI5_TX_SYNC PDM: AUDIOMIX_PDM_BIT_STREAM01 GPIO: GPIO3_IO22 CAN: CAN1_TX	DO	1.8V	
P144	CAN0_RX	SAI: AUDIOMIX_SAI5_RX_DATA02 SAI: AUDIOMIX_SAI1_TX_DATA04 SAI: AUDIOMIX_SAI1_TX_SYNC SAI: AUDIOMIX_SAI5_TX_BCLK PDM: AUDIOMIX_PDM_BIT_STREAM02 GPIO: GPIO3_IO23 CAN: CAN1_RX	DI	1.8V	

SMARC Pin #	SMARC Pin Name	CPU PIN / Multiplexing (red = default muxing)	I/O	I/O Level	Comments
P145	CAN1_TX	SAI: AUDIOMIX_SAI5_RX_DATA03 SAI: AUDIOMIX_SAI1_TX_DATA05 SAI: AUDIOMIX_SAI1_TX_SYNC SAI: AUDIOMIX_SAI5_TX_DATA00 PDM: AUDIOMIX_PDM_BIT_STREAM03 GPIO: GPIO3_IO24 CAN: CAN2_TX	DO	1.8V	
P146	CAN1_RX	SAI: AUDIOMIX_SAI5_MCLK SAI: AUDIOMIX_SAI1_TX_BCLK PWM: PWM1_OUT I2C: I2C5_SDA GPIO: GPIO3_IO25 CAN: CAN2_RX	DI	1.8V	
P147	VDD_IN	VSYS	A	3.0 - 5.25V	
P148	VDD_IN	VSYS	A	3.0 - 5.25V	
P149	VDD_IN	VSYS	A	3.0 - 5.25V	
P150	VDD_IN	VSYS	A	3.0 - 5.25V	
P151	VDD_IN	VSYS	A	3.0 - 5.25V	
P152	VDD_IN	VSYS	A	3.0 - 5.25V	
P153	VDD_IN	VSYS	A	3.0 - 5.25V	
P154	VDD_IN	VSYS	A	3.0 - 5.25V	
P155	VDD_IN	VSYS	A	3.0 - 5.25V	
P156	VDD_IN	VSYS	A	3.0 - 5.25V	
S1	CSI1_TX+ / I2C_CAM1_CK	SC1	DO	1.8V	From I2C expander (U13)
S2	CSI1_TX- / I2C_CAM1_DAT	SD1	DI/O	1.8V	From I2C expander (U13)
S3	GND	NA	-	NA	
S4	RSVD	NA	-	NA	
S5	I2C_CAM0_CK / CSI0_TX+	SC0	DO	1.8V	From I2C expander (U13)
S6	CAM_MCK	GPIO: GPIO1_IO15 USB: USB2_OC USDHC: USDHC3_WP PWM: PWM4_OUT CCM: CCM_CLK02	DO	1.8V	
S7	I2C_CAM0_DAT / CSI0_TX-	SD0	DI/O	1.8V	From I2C expander (U13)
S8	CSI0_CK+	MIPI_CSI1_CLK_P	DO	1.8V	
S9	CSI0_CK-	MIPI_CSI1_CLK_N	DO	1.8V	
S10	GND	NA	-	NA	
S11	CSI0_RX0+	MIPI_CSI1_D0_P	DI	1.8V	

SMARC Pin #	SMARC Pin Name	CPU PIN / Multiplexing (red = default muxing)	I/O	I/O Level	Comments
S12	CSI0_RX0-	MIPI_CSI1_D0_N	DI	1.8V	
S13	GND	NA	-	NA	
S14	CSI0_RX1+	MIPI_CSI1_D1_P	DI	1.8V	
S15	CSI0_RX1-	MIPI_CSI1_D1_N	DI	1.8V	
S16	GND	NA	-	NA	
S17	GBE1_MDI0+	TXRXP_A	DI/O	1.8V	From KSZ9031 (U16)
S18	GBE1_MDI0-	TXRXM_A	DI/O	1.8V	From KSZ9031 (U16)
S19	GBE1_LINK100#	LED2	DO	3.3V	From KSZ9031 (U16) LED2 if SAI3_RXC is low
S20	GBE1_MDI1+	TXRXP_B	DI/O	1.8V	From KSZ9031 (U16)
S21	GBE1_MDI1-	TXRXM_B	DI/O	1.8V	From KSZ9031 (U16)
S22	GBE1_LINK1000#	LED2	DO	3.3V	From KSZ9031 (U16) LED2 if SAI3_RXC is high
S23	GBE1_MDI2+	TXRXP_C	DI/O	1.8V	From KSZ9031 (U16)
S24	GBE1_MDI2-	TXRXM_C	DI/O	1.8V	From KSZ9031 (U16)
S25	GND	NA	-	NA	
S26	GBE1_MDI3+	TXRXP_D	DI/O	1.8V	From KSZ9031 (U16)
S27	GBE1_MDI3-	TXRXM_D	DI/O	1.8V	From KSZ9031 (U16)
S28	GBE1_CTREF	TP34	-	NA	Test point
S29	PCIE_D_TX+ / SERDES_0_TX+	NA	-	NA	
S30	PCIE_D_TX- / SERDES_0_TX-	NA	-	NA	
S31	GBE1_LINK_ACT#	LED1	DO	3.3V	
S32	PCIE_D_RX+ / SERDES_0_RX+	NA	-	NA	
S33	PCIE_D_RX- / SERDES_0_RX-	NA	-	NA	
S34	GND	NA	-	NA	
S35	USB4+	USB2DN_DP4	DI/O	3.3V	From USB Hub (U9)
S36	USB4-	USB2DN_DM4	DI/O	3.3V	From USB Hub (U9)
S37	USB3_VBUS_DET	NA	-	NA	
S38	AUDIO_MCK	SAI: AUDIOMIX_SAI3_MCLK PWM: PWM4_OUT SAI: AUDIOMIX_SAI5_MCLK SPDIF: AUDIOMIX_SPDIF1_OUT GPIO: GPIO5_IO02 SPDIF: AUDIOMIX_SPDIF1_IN	DO	1.8V	

SMARC Pin #	SMARC Pin Name	CPU PIN / Multiplexing (red = default muxing)	I/O	I/O Level	Comments
S39	I2S0_LRCK	SAI: AUDIOMIX_SAI3_TX_SYNC SAI: AUDIOMIX_SAI2_TX_DATA01 SAI: AUDIOMIX_SAI5_RX_DATA01 SAI: AUDIOMIX_SAI3_TX_DATA01 UART: UART2_DCE_RX UART: UART2_DTE_TX GPIO: GPIO4_IO31 PDM: AUDIOMIX_PDM_BIT_STREAM03	DI/O	1.8V	
S40	I2S0_SDOUT	SAI: AUDIOMIX_SAI3_TX_DATA00 SAI: AUDIOMIX_SAI2_TX_DATA03 SAI: AUDIOMIX_SAI5_RX_DATA03 TIMER: GPT1_CAPTURE2 SPDIF: AUDIOMIX_SPDIF1_EXT_CLK GPIO: GPIO5_IO01	DO	1.8V	
S41	I2S0_SDIN	SAI: AUDIOMIX_SAI3_RX_DATA00 SAI: AUDIOMIX_SAI2_RX_DATA03 SAI: AUDIOMIX_SAI5_RX_DATA00 UART: UART2_DCE_RTS UART: UART2_DTE_CTS GPIO: GPIO4_IO30 PDM: AUDIOMIX_PDM_BIT_STREAM01	DI	1.8V	
S42	I2S0_CK	SAI: AUDIOMIX_SAI3_TX_BCLK SAI: AUDIOMIX_SAI2_TX_DATA02 SAI: AUDIOMIX_SAI5_RX_DATA02 TIMER: GPT1_CAPTURE1 UART: UART2_DCE_TX UART: UART2_DTE_RX GPIO: GPIO5_IO00 PDM: AUDIOMIX_PDM_BIT_STREAM02	DI/O	1.8V	
S43	ESPI_ALERT0#	NA	-	NA	
S44	ESPI_ALERT1#	NA	-	NA	
S45	MDIO_CLK	NA	-	NA	
S46	MDIO_DAT	NA	-	NA	
S47	GND	NA	-	NA	
S48	I2C_GP_CK	I2C: I2C2_SCL ENET: ENET_QOS_1588_EVENT1_IN SDHC: USDHC3_CD_B SPI: ECSP11_MISO ENET: ENET_QOS_1588_EVENT1_AUX_IN GPIO: GPIO5_IO16	DO	1.8V	
S49	I2C_GP_DAT	I2C: I2C2_SDA ENET: ENET_QOS_1588_EVENT1_OUT SDHC: USDHC3_WP SPI: ECSP11_SS0 GPIO: GPIO5_IO17	DI/O	1.8V	

SMARC Pin #	SMARC Pin Name	CPU PIN / Multiplexing (red = default muxing)	I/O	I/O Level	Comments
S50	I2S2_LRCK / HDA_SYNC	SAI: AUDIOMIX_SAI2_TX_SYNC SAI: AUDIOMIX_SAI5_TX_DATA01 ENET: ENET_QOS_1588_EVENT3_OUT SAI: AUDIOMIX_SAI2_TX_DATA01 UART: UART1_DCE_CTS UART: UART1_DTE_RTS GPIO: GPIO4_IO24 PDM: AUDIOMIX_PDM_BIT_STREAM02	DI/O	1.8V	
S51	I2S2_SDOUT / HDA_SDO	SAI: AUDIOMIX_SAI2_TX_DATA00 SAI: AUDIOMIX_SAI5_TX_DATA03 ENET: ENET_QOS_1588_EVENT2_IN CAN: CAN2_TX ENET: ENET_QOS_1588_EVENT2_AUX_IN GPIO: GPIO4_IO26	DO	1.8V	
S52	I2S2_SDIN / HDA_SDI	SAI: AUDIOMIX_SAI2_RX_DATA00 SAI: AUDIOMIX_SAI5_TX_DATA00 ENET: ENET_QOS_1588_EVENT2_OUT SAI: AUDIOMIX_SAI2_TX_DATA01 UART: UART1_DCE_RTS UART: UART1_DTE_CTS GPIO: GPIO4_IO23 PDM: AUDIOMIX_PDM_BIT_STREAM03	DI	1.8V	
S53	I2S2_CK / HDA_CK	SAI: AUDIOMIX_SAI2_TX_BCLK SAI: AUDIOMIX_SAI5_TX_DATA02 CAN: CAN1_RX GPIO: GPIO4_IO25 PDM: AUDIOMIX_PDM_BIT_STREAM01	DI/O	1.8V	
S54	SATA_ACT#	NA	-	NA	
S55	USB5_EN_OC#	NA	-	NA	
S56	ESPI_IO_2 / QSPI_IO_2	NA	-	NA	
S57	ESPI_IO_3 / QSPI_IO_3	NA	-	NA	
S58	ESPI_RESET#	NA	-	NA	
S59	USB5+	NA	-	NA	
S60	USB5-	NA	-	NA	
S61	GND	NA	-	NA	
S62	USB3_SSTX+	USB3DN_TXDP1	DI/O	3.3V	From USB Hub (U9)
S63	USB3_SSTX-	USB3DN_TXDM1	DI/O	3.3V	From USB Hub (U9)
S64	GND	NA	-	NA	
S65	USB3_SSRX+	USB3DN_RXDP1	DI/O	3.3V	From USB Hub (U9)
S66	USB3_SSRX-	USB3DN_RXDM1	DI/O	3.3V	From USB Hub (U9)
S67	GND	NA	-	NA	

SMARC Pin #	SMARC Pin Name	CPU PIN / Multiplexing (red = default muxing)	I/O	I/O Level	Comments
S68	USB3+	USB2DN_DP1	DI/O	3.3V	From USB Hub (U9)
S69	USB3-	USB2DN_DM1	DI/O	3.3V	From USB Hub (U9)
S70	GND	NA	-	NA	
S71	USB2_SSTX+	USB3DN_TXDP3	DI/O	3.3V	From USB Hub (U9)
S72	USB2_SSTX-	USB3DN_TXDM3	DI/O	3.3V	From USB Hub (U9)
S73	GND	NA	-	NA	
S74	USB2_SSRX+	USB3DN_RXDP3	DI/O	3.3V	From USB Hub (U9)
S75	USB2_SSRX-	USB3DN_RXDM3	DI/O	3.3V	From USB Hub (U9)
S76	PCIE_B_RST#	NA	-	NA	
S77	PCIE_C_RST#	NA	-	NA	
S78	PCIE_C_RX+ / SERDES_1_RX+	NA	-	NA	
S79	PCIE_C_RX- / SERDES_1_RX-	NA	-	NA	
S80	GND	NA	-	NA	
S81	PCIE_C_TX+ / SERDES_1_TX+	NA	-	NA	
S82	PCIE_C_TX- / SERDES_1_TX-	NA	-	NA	
S83	GND	NA	-	NA	
S84	PCIE_B_REFCK+	NA	-	NA	
S85	PCIE_B_REFCK-	NA	-	NA	
S86	GND	NA	-	NA	
S87	PCIE_B_RX+	NA	-	NA	
S88	PCIE_B_RX-	NA	-	NA	
S89	GND	NA	-	NA	
S90	PCIE_B_TX+	NA	-	NA	
S91	PCIE_B_TX-	NA	-	NA	
S92	GND	NA	-	NA	
S93	DPO_LANE0+	NA	-	NA	
S94	DPO_LANE0-	NA	-	NA	
S95	DPO_AUX_SEL	NA	-	NA	
S96	DPO_LANE1+	NA	-	NA	
S97	DPO_LANE1-	NA	-	NA	
S98	DPO_HPD	NA	-	NA	
S99	DPO_LANE2+	NA	-	NA	
S100	DPO_LANE2-	NA	-	NA	
S101	GND	NA	-	NA	
S102	DPO_LANE3+	NA	-	NA	

SMARC Pin #	SMARC Pin Name	CPU PIN / Multiplexing (red = default muxing)	I/O	I/O Level	Comments
S103	DP0_LANE3-	NA	-	NA	
S104	USB3_OTG_ID	NA	-	NA	
S105	DP0_AUX+	NA	-	NA	
S106	DP0_AUX-	NA	-	NA	
S107	LCD1_BKLT_EN	NAND: NAND_CLE SPI: FLEXSPI_B_SCLK SDHC: USDHC3_DATA7 UART: UART4_DCE_RX UART: UART4_DTE_TX GPIO: GPIO3_IO05 DEBUG: CORESIGHT_TRACE03	DI/O	1.8V	
S108	LVDS1_CK+ / eDP1_AUX+ / DSI1_CLK+	LVDS1_CLK_P	DO	1.8V	
S109	LVDS1_CK- / eDP1_AUX- / DSI1_CLK-	LVDS1_CLK_N	DO	1.8V	
S110	GND	NA	-	NA	
S111	LVDS1_0+ / eDP1_TX0+ / DSI1_D0+	LVDS1_TX0_P	DO	1.8V	
S112	LVDS1_0- / eDP1_TX0- / DSI1_D0-	LVDS1_TX0_N	DO	1.8V	
S113	eDP1_HPD / DSI1_TE	TP27	-	NA	Test point
S114	LVDS1_1+ / eDP1_TX1+ / DSI1_D1+	LVDS1_TX1_P	DO	1.8V	
S115	LVDS1_1- / eDP1_TX1- / DSI1_D1-	LVDS1_TX1_N	DO	1.8V	
S116	LCD1_VDD_EN	GPIO: GPIO1_IO05 M7: M7_NMI ISP: ISP_FL_TRIG_1 CLK: CCM_PMIC_READY	DI/O	1.8V	
S117	LVDS1_2+ / eDP1_TX2+ / DSI1_D2+	LVDS1_TX2_P	DO	1.8V	
S118	LVDS1_2- / eDP1_TX2- / DSI1_D2-	LVDS1_TX2_N	DO	1.8V	
S119	GND	NA	-	NA	
S120	LVDS1_3+ / eDP1_TX3+ / DSI1_D3+	LVDS1_TX3_P	DO	1.8V	
S121	LVDS1_3- / eDP1_TX3- / DSI1_D3-	LVDS1_TX3_N	DO	1.8V	
S122	LCD1_BKLT_PWM	TIMER: GPT1_COMPARE3 GPIO: GPIO5_IO05 SPDIF: AUDIOMIX_SPDIF1_EXT_CLK PWM: PWM1_OUT	DO	1.8V	

SMARC Pin #	SMARC Pin Name	CPU PIN / Multiplexing (red = default muxing)	I/O	I/O Level	Comments
S123	GPIO13	GPIO: GPIO1_IO00 CCM: CCM_ENET_PHY_REF_CLK_ROOT ISP: ISP_FL_TRIG_0 SAI: ANAMIX_REF_CLK_32K CCM: CCM_EXT_CLK1	DI/O	1.8V	
S124	GND	NA	-	NA	
S125	LVDS0_0+ / eDP0_TX0+ / DSI0_D0+	MIPI_DSI1_D0_P	DO	1.8V	LVDS0_TX0_P option (swap R827 & R836)
S126	LVDS0_0- / eDP0_TX0- / DSI0_D0-	MIPI_DSI1_D0_N	DO	1.8V	LVDS0_TX0_N option (swap R829 & R837)
S127	LCD0_BKLT_EN	NAND: NAND_RE_B SPI: FLEXSPI_B_DQS SDHC: USDHC3_DATA4 UART: UART4_DCE_TX UART: UART4_DTE_RX GPIO: GPIO3_IO15 DEBUG: CORESIGHT_TRACE13	DO	1.8V	
S128	LVDS0_1+ / eDP0_TX1+ / DSI0_D1+	MIPI_DSI1_D1_P	DO	1.8V	LVDS0_TX1_P option (swap R830 & R838)
S129	LVDS0_1- / eDP0_TX1- / DSI0_D1-	MIPI_DSI1_D1_N	DO	1.8V	LVDS0_TX1_N option (swap R831 & R839)
S130	GND	NA	-	NA	
S131	LVDS0_2+ / eDP0_TX2+ / DSI0_D2+	MIPI_DSI1_D2_P	DO	1.8V	LVDS0_TX2_P option (swap R832 & R840)
S132	LVDS0_2- / eDP0_TX2- / DSI0_D2-	MIPI_DSI1_D2_N	DO	1.8V	LVDS0_TX2_N option (swap R833 & R841)
S133	LCD0_VDD_EN	SAI: AUDIOMIX_SAI1_RX_DATA01 PDM: AUDIOMIX_PDM_BIT_STREAM01 ENET: ENET1_1588_EVENT1_OUT GPIO: GPIO4_IO03	DO	1.8V	
S134	LVDS0_CLK+ / eDP0_AUX+ / DSI0_CLK+	MIPI_DSI1_CLK_P	DO	1.8V	LVDS0_CLK_P option (swap R823 & R825)
S135	LVDS0_CLK- / eDP0_AUX- / DSI0_CLK-	MIPI_DSI1_CLK_N	DO	1.8V	LVDS0_CLK_N option (swap R824 & R826)
S136	GND	NA	-	NA	
S137	LVDS0_3+ / eDP0_TX3+ / DSI0_D3+	MIPI_DSI1_D3_P	DO	1.8V	LVDS0_TX3_P option (swap R834 & R842)
S138	LVDS0_3- / eDP0_TX3- / DSI0_D3-	MIPI_DSI1_D3_N	DO	1.8V	LVDS0_TX3_N option (swap R835 & R843)

SMARC Pin #	SMARC Pin Name	CPU PIN / Multiplexing (red = default muxing)	I/O	I/O Level	Comments
S139	I2C_LCD_CK	I2C: I2C3_SCL PWM: PWM4_OUT CLK: GPT2_CLK SPI: ECSPI2_SCLK GPIO: GPIO5_IO18	DO	1.8V	
S140	I2C_LCD_DAT	I2C: I2C3_SDA PWM: PWM3_OUT CLK: GPT3_CLK SPI: ECSPI2_MOSI GPIO: GPIO5_IO19	DIO	1.8V	
S141	LCD0_BKLT_PWM	SPDIF: AUDIOMIX_SPDIF1_IN PWM: PWM2_OUT I2C: I2C5_SDA TIMER: GPT1_COMPARE2 CAN: CAN1_RX GPIO: GPIO5_IO04	DI/O	1.8V	
S142	GPIO12	NAND: NAND_CE1_B SPI: FLEXSPI_A_SS1_B USDHC: USDHC3_STROBE I2C: I2C4_SCL GPIO: GPIO3_IO02 DEBUG: CORESIGHT_TRACE00	DI/O	1.8V	
S143	GND	NA	-	NA	
S144	eDP0_HPD / DSI0_TE	TP26	-	NA	Test point
S145	WDT_TIME_OUT#	WD0G_B	DO	1.8V	
S146	PCIE_WAKE#	SAI: AUDIOMIX_SAI3_RX_SYNC SAI: AUDIOMIX_SAI2_RX_DATA01 SAI: AUDIOMIX_SAI5_RX_SYNC SAI: AUDIOMIX_SAI3_RX_DATA01 SPDIF: AUDIOMIX_SPDIF1_IN GPIO: GPIO4_IO28 PDM: AUDIOMIX_PDM_BIT_STREAM00	DI	3.3V	
S147	VDD_RTC	NVCC_SNVS	A	1.8V	
S148	LID#	GPIO: GPIO1_IO11 USB: USB2_ID PWM: PWM2_OUT SDHC: USDHC3_VSELECT CLK: CCM_PMIC_READY	DI	1.8 - 5V	
S149	SLEEP#	GPIO: GPIO1_IO08 ENET; ENET_QOS_1588_EVENT0_IN PWM: PWM1_OUT ISP: ISP_PRELIGHT_TRIG_1 ENET: ENET_QOS_1588_EVENT0_AUX_IN SDHC: USDHC2_RESET_B	DI	1.8 - 5V	
S150	VIN_PWR_BAD#	PMIC_RST_B	DI	VDD_IN	

SMARC Pin #	SMARC Pin Name	CPU PIN / Multiplexing (red = default muxing)	I/O	I/O Level	Comments
S151	CHARGING#	GPB6	DI	1.8 - 5V	From GPIO expander (U14)
S152	CHARGER_PRSENT#	SAI: AUDIOMIX_SAI1_TX_DATA07 SAI: AUDIOMIX_SAI6_MCLK PDM: AUDIOMIX_PDM_CLK ENET: ENET1_TX_ER GPIO: GPIO4_IO19	DI	1.8 - 5V	
S153	CARRIER_STBY#	GPIO: GPIO1_IO09 ENET: ENET_QOS_1588_EVENT0_OUT PWM: PWM2_OUT ISP: ISP_SHUTTER_OPEN_1 SDHC: USDHC3_RESET_B DMA: SDMA2_EXT_EVENT00	DO	1.8V	
S154	CARRIER_PWR_ON	GPIO: GPIO1_IO10 USB: USB1_ID PWM: PWM3_OUT	DO	1.8V	
S155	FORCE_RECOV#	BOOT_MODE0	DI	1.8V	High = USB recovery
S156	BATLOW#	GPB7	DI	1.8 - 5V	From GPIO expander (U14)
S157	TEST#	TP43	DI	1.8 - 5V	Test point
S158	GND	NA	-	NA	

11 Mechanical and PCB Footprint Specification

Module dimensions of the Nitrogen8M Plus SMARC are 82 x 50 mm. Detail drawings are shown below.

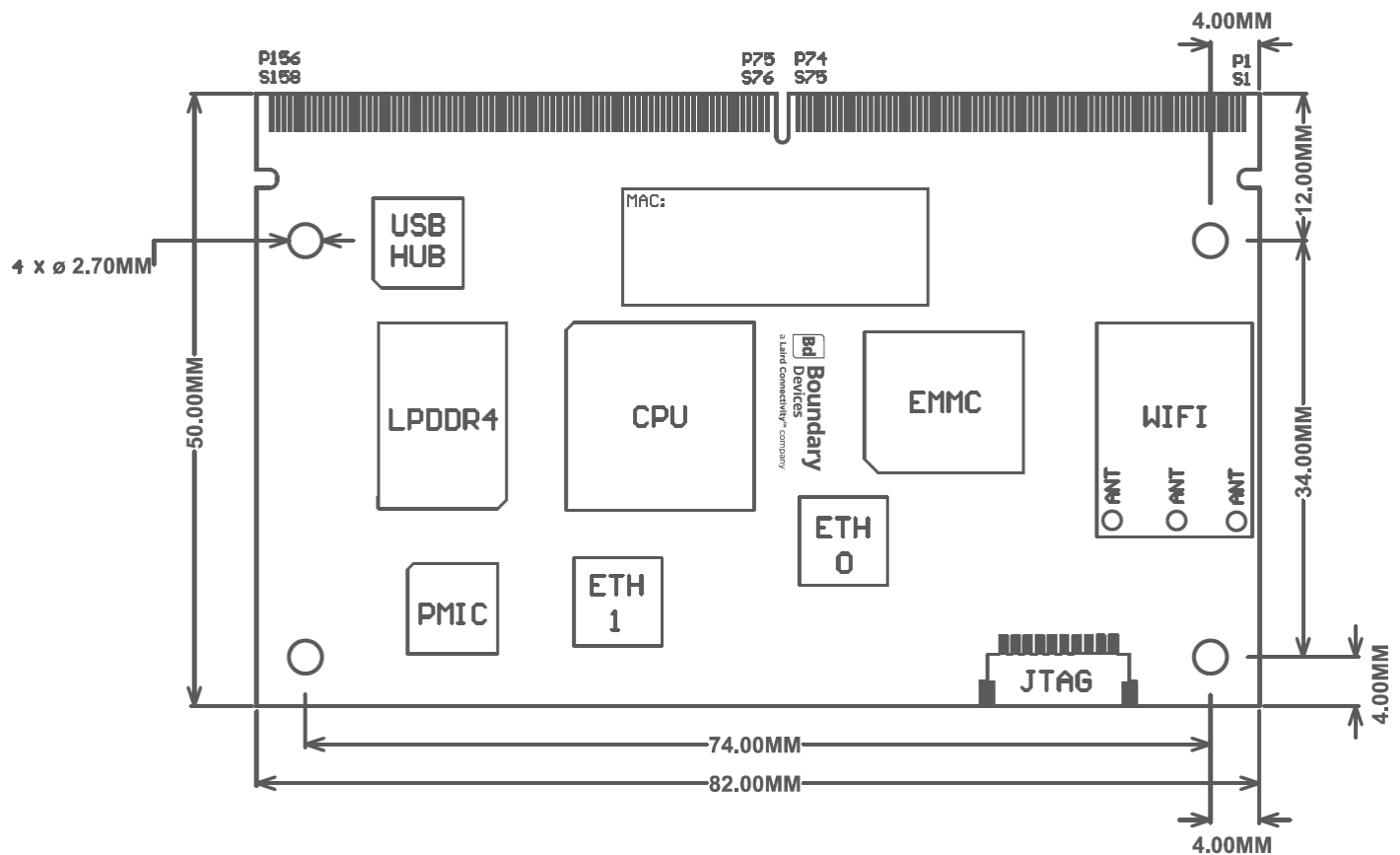
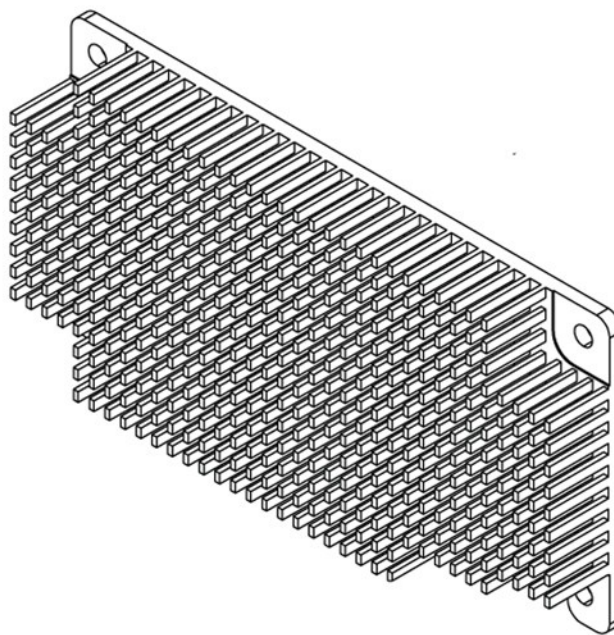
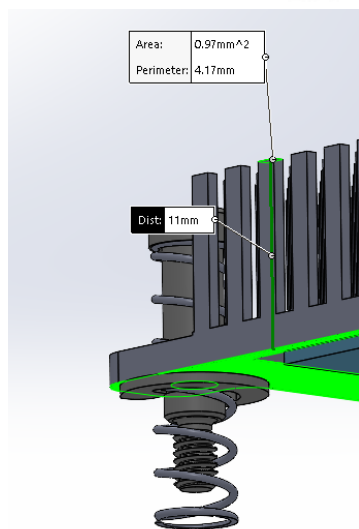
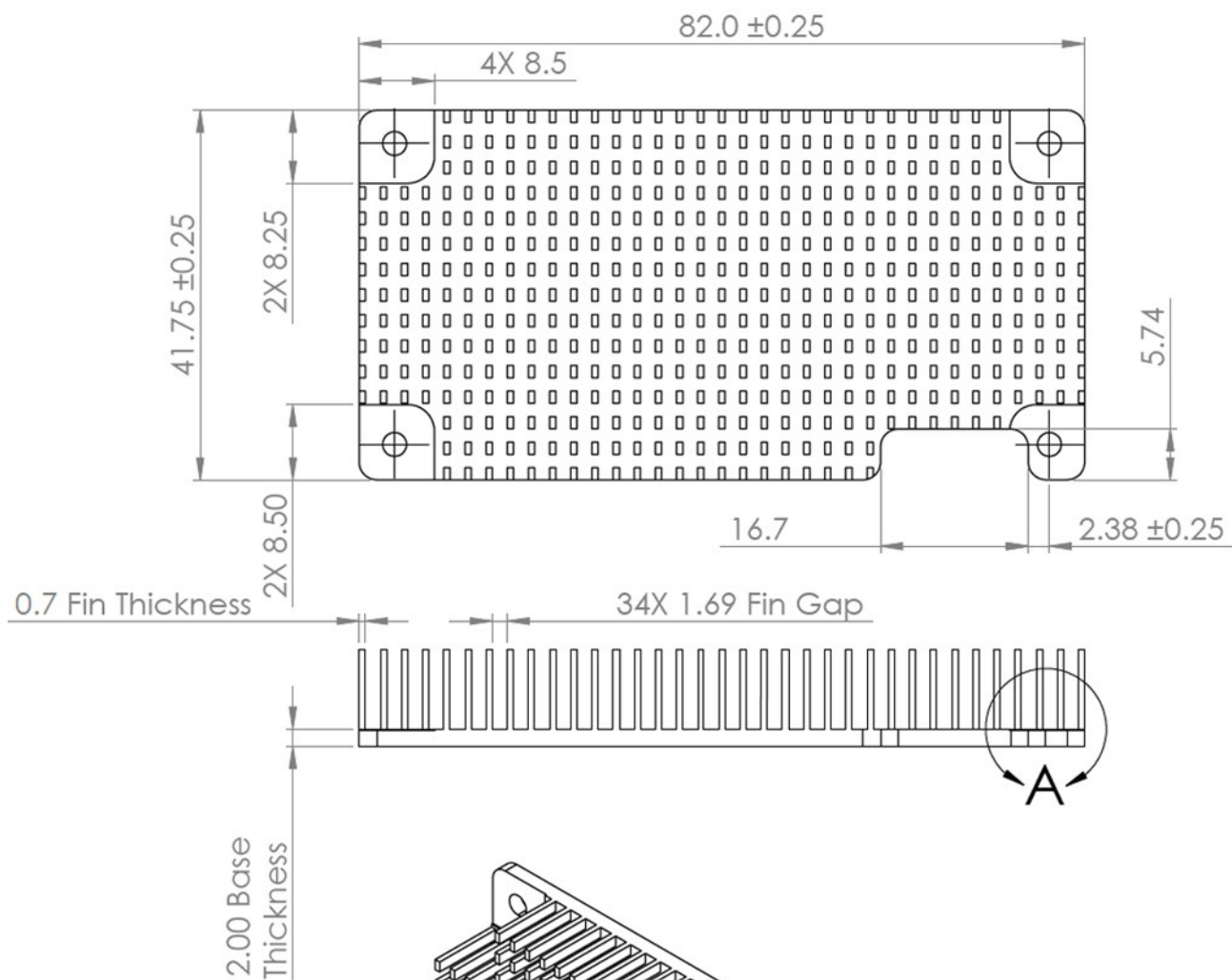


Figure 3: Mechanical and PCB Footprint Specs

12 Heatsink



Part Number: 450-00182 | Material: Aluminum

13 Storage Instructions

Required Storage Conditions:

- Prior to Opening the Dry Packing**

The following are required storage conditions prior to opening the dry packing:

- Normal temperature: 5~40°C
- Normal humidity: 80% (Relative humidity) or less
- Storage period: One year or less

14 Ordering Information

Table 9: Orderable Parts

Order Model	Description
N8MP_SMARC_SOM_2r16e	SMARC SOM: i.MX8M Quad Plus / 2GB / 16GB eMMC / 0°C to +70°C / Without wireless
N8MP_SMARC_SOM_2r16e_i	SMARC SOM: i.MX8M Quad Plus / 2GB / 16GB eMMC / -40°C to +85°C / Without wireless
N8MP_SMARC_SOM_2r16e_IF573_3M	SMARC SOM: i.MX8M Quad Plus / 2GB / 16GB eMMC / 0°C to +70°C / Sona IF573 / 3x MHF4L
N8MP_SMARC_SOM_2r16e_IF573_3M_i	SMARC SOM: i.MX8M Quad Plus / 2GB / 16GB eMMC / -40°C to +85°C / Sona IF573 / 3x MHF4L
N8MP_SMARC_SOM_2r16e_NX611_1M	SMARC SOM: i.MX8M Quad Plus / 2GB / 16GB eMMC / 0°C to +70°C / Sona NX611 / 1x MHF4L
N8MP_SMARC_SOM_2r16e_NX611_1M_i	SMARC SOM: i.MX8M Quad Plus / 2GB / 16GB eMMC / -40°C to +85°C / Sona NX611 / 1x MHF4L
N8MP_SMARC_SOM_4r16e	SMARC SOM: i.MX8M Quad Plus / 4GB / 16GB eMMC / 0°C to +70°C / Without wireless
N8MP_SMARC_SOM_4r16e_i	SMARC SOM: i.MX8M Quad Plus / 4GB / 16GB eMMC / -40°C to +85°C / Without wireless
N8MP_SMARC_SOM_4r16e_IF573_3M	SMARC SOM: i.MX8M Quad Plus / 4GB / 16GB eMMC / 0°C to +70°C / Sona IF573 / 3x MHF4L
N8MP_SMARC_SOM_4r16e_IF573_3M_i	SMARC SOM: i.MX8M Quad Plus / 4GB / 16GB eMMC / -40°C to +85°C / Sona IF573 / 3x MHF4L
N8MP_SMARC_SOM_4r16e_NX611_1M	SMARC SOM: i.MX8M Quad Plus / 4GB / 16GB eMMC / 0°C to +70°C / Sona NX611 / 1x MHF4L
N8MP_SMARC_SOM_4r16e_NX611_1M_i	SMARC SOM: i.MX8M Quad Plus / 4GB / 16GB eMMC / -40°C to +85°C / Sona NX611 / 1x MHF4L
N8MP_SMARC_SOM_8r16e	SMARC SOM: i.MX8M Quad Plus / 8GB / 16GB eMMC / 0°C to +70°C / Without wireless
N8MP_SMARC_SOM_8r16e_i	SMARC SOM: i.MX8M Quad Plus / 8GB / 16GB eMMC / -40°C to +85°C / Without wireless
N8MP_SMARC_SOM_8r16e_IF573_3M	SMARC SOM: i.MX8M Quad Plus / 8GB / 16GB eMMC / 0°C to +70°C / Sona IF573 / 3x MHF4L
N8MP_SMARC_SOM_8r16e_IF573_3M_i	SMARC SOM: i.MX8M Quad Plus / 8GB / 16GB eMMC / -40°C to +85°C / Sona IF573 / 3x MHF4L
N8MP_SMARC_SOM_8r16e_NX611_1M	SMARC SOM: i.MX8M Quad Plus / 8GB / 16GB eMMC / 0°C to +70°C / Sona NX611 / 1x MHF4L
N8MP_SMARC_SOM_8r16e_NX611_1M_i	SMARC SOM: i.MX8M Quad Plus / 8GB / 16GB eMMC / -40°C to +85°C / Sona NX611 / 1x MHF4L
450-00182	Heatsink for Nitrogen8M+ SMARC family
SMARC_CAR	Kit - Universal SMARC Carrier Board. Includes 3x EFB2471A3S-10MH4L and 2x 001-0021 antennas, power supply, DB9 cable
SMARC_CAR_BRD	Universal Carrier Board - SMARC (Note: SOM sold separately.)

15 Regulatory

Radio certifications for SOMs with wireless options are held under the specific wireless module listings:

Table 10: Regulatory Information

Order Model with Wireless	Module Product Page	RIG
N8MP_SMARC_SOM_2r16e_NX611_1M	Sona NX611	Sona NX611 Regulatory Information (Coming Soon)
N8MP_SMARC_SOM_2r16e_NX611_1M_i	Sona NX611	Sona NX611 Regulatory Information (Coming Soon)
N8MP_SMARC_SOM_4r16e_NX611_1M	Sona NX611	Sona NX611 Regulatory Information (Coming Soon)
N8MP_SMARC_SOM_4r16e_NX611_1M_i	Sona NX611	Sona NX611 Regulatory Information (Coming Soon)
N8MP_SMARC_SOM_8r16e_NX611_1M	Sona NX611	Sona NX611 Regulatory Information (Coming Soon)
N8MP_SMARC_SOM_8r16e_NX611_1M_i	Sona NX611	Sona NX611 Regulatory Information (Coming Soon)
N8MP_SMARC_SOM_2r16e_IF573_3M	Sona IF573	Sona IF573 Regulatory information
N8MP_SMARC_SOM_2r16e_IF573_3M_i	Sona IF573	Sona IF573 Regulatory information
N8MP_SMARC_SOM_4r16e_IF573_3M	Sona IF573	Sona IF573 Regulatory information
N8MP_SMARC_SOM_4r16e_IF573_3M_i	Sona IF573	Sona IF573 Regulatory information
N8MP_SMARC_SOM_8r16e_IF573_3M	Sona IF573	Sona IF573 Regulatory information
N8MP_SMARC_SOM_8r16e_IF573_3M_i	Sona IF573	Sona IF573 Regulatory information

16 Additional Information

Please contact your local sales representative or our support team for further assistance:

Headquarters	Ezurio 50 S. Main St. Suite 1100 Akron, OH 44308 USA
Website	http://www.ezurio.com
Technical Support	http://www.ezurio.com/resources/support
Sales Contact	http://www.ezurio.com/contact

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